# SN54ABT16241A, SN74ABT16241A 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

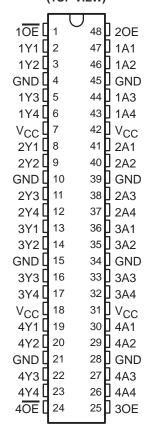
SCBS096G - FEBRUARY 1991 - REVISED OCTOBER 1998

- Members of the Texas Instruments Widebus™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Typical V<sub>OLP</sub> (Output Ground Bounce) < 1 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C
- Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA I<sub>OH</sub>, 64-mA I<sub>OL</sub>)
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

#### description

The 'ABT16241A devices are 16-bit buffers and line drivers designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

SN54ABT16241A . . . WD PACKAGE SN74ABT16241A . . . DGG, DGV, OR DL PACKAGE (TOP VIEW)



These devices can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. These devices provide true outputs and complementary output-enable (OE and  $\overline{OE}$ ) inputs.

To ensure the high-impedance state during power up or power down,  $\overline{\text{OE}}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver. OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The SN54ABT16241A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT16241A is characterized for operation from –40°C to 85°C.



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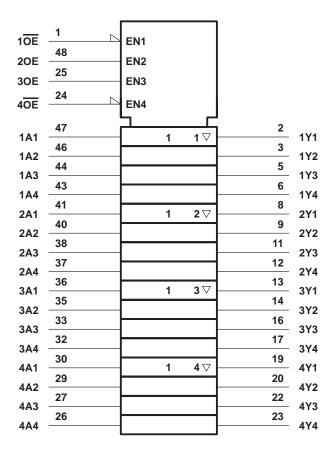


#### **FUNCTION TABLES**

| INPU'    | INPUTS |        |  |  |  |  |  |
|----------|--------|--------|--|--|--|--|--|
| 10E, 40E | 1A, 4A | 1Y, 4Y |  |  |  |  |  |
| L        | Н      | Н      |  |  |  |  |  |
| L        | L      | L      |  |  |  |  |  |
| Н        | X      | Z      |  |  |  |  |  |

| INPU'    | INPUTS |        |  |  |  |  |  |  |
|----------|--------|--------|--|--|--|--|--|--|
| 20E, 30E | 2A, 3A | 2Y, 3Y |  |  |  |  |  |  |
| Н        | Н      | Н      |  |  |  |  |  |  |
| Н        | L      | L      |  |  |  |  |  |  |
| L        | X      | Z      |  |  |  |  |  |  |

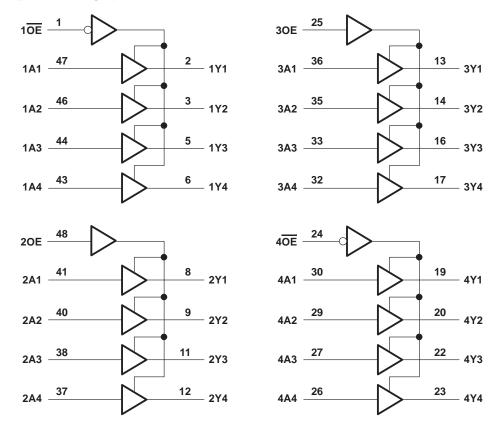
# logic symbol†



<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



## logic diagram (positive logic)



# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub>                      |             |                |
|--|-------------|----------------|
| Voltage range applied to any output in the high o          |             |                |
| Current into any output in the low state, Io: SN5-         |             |                |
| SN7  | 74ABT16241A | 128 mA         |
| Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)  |             | –18 mA         |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0) |             | –50 mA         |
| Package thermal impedance, θ <sub>JA</sub> (see Note 2): [ | DGG package | 89°C/W         |
|  | DGV package | 93°C/W         |
| ]  | DL package  | 94°C/W         |
| Storage temperature range, T <sub>stg</sub>                |             | –65°C to 150°C |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.



# SN54ABT16241A, SN74ABT16241A 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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## recommended operating conditions (see Note 3)

|                |   |                 | SN54ABT | 16241A | SN74ABT | 16241A | UNIT |
|----------------|---|-----------------|---------|--------|---------|--------|------|
|                |   |                 | MIN     | MAX    | MIN     | MAX    | UNIT |
| VCC            | Supply voltage                          |                 | 4.5     | 5.5    | 4.5     | 5.5    | V    |
| VIH            | High-level input voltage                |                 | 2       |        | 2       |        | V    |
| VIL            | V <sub>IL</sub> Low-level input voltage |                 |         |        |         | 0.8    | V    |
| ٧ <sub>I</sub> | Input voltage                           |                 | 0       | Vcc    | 0       | Vcc    | V    |
| loh            | High-level output current               |                 |         | -24    |         | -32    | mA   |
| loL            | Low-level output current                |                 | 48      |        | 64      | mA     |      |
| Δt/Δν          | Input transition rise or fall rate      | Outputs enabled |         | 10     |         | 10     | ns/V |
| TA             | Operating free-air temperature          |                 | -55     | 125    | -40     | 85     | °C   |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAA            | AETED          | TEST 00  | Т                                | A = 25°C | ;                | SN54ABT1 | 16241A | SN74ABT1 | 6241A | UNIT |      |  |
|------------------|----------------|--|----------------------------------|----------|------------------|----------|--------|----------|-------|------|------|--|
| PARAM            | MEIER          | I IEST CO  | NDITIONS                         | MIN      | TYP <sup>†</sup> | MAX      | MIN    | MAX      | MIN   | MAX  | UNII |  |
| VIK              |                | V <sub>CC</sub> = 4.5 V,                                   | I <sub>I</sub> = -18 mA          |          |                  | -1.2     |        | -1.2     |       | -1.2 | V    |  |
|                  |                | $V_{CC} = 4.5 \text{ V},$                                  | I <sub>OH</sub> = -3 mA          | 2.5      |                  |          | 2.5    |          | 2.5   |      |      |  |
| \/               |                | $V_{CC} = 5 V$ ,   | $I_{OH} = -3 \text{ mA}$         | 3        |                  |          | 3      |          | 3     |      | V    |  |
| VOH              |                | V <sub>CC</sub> = 4.5 V                                    | I <sub>OH</sub> = -24 mA         | 2        |                  |          | 2      |          |       |      | V    |  |
|                  |                | VCC = 4.5 V  | I <sub>OH</sub> = -32 mA         | 2*       |                  |          |        |          | 2     |      |      |  |
| VOL              |                | V <sub>CC</sub> = 4.5 V                                    | I <sub>OL</sub> = 48 mA          |          |                  | 0.55     |        | 0.55     |       |      | V    |  |
| VOL              |                | VCC = 4.5 V  | I <sub>OL</sub> = 64 mA          |          |                  | 0.55*    |        |          |       | 0.55 | V    |  |
| $V_{hys}$        |                |  |                                  |          | 100              |          |        |          |       |      | mV   |  |
| П                |                | $V_{CC} = 5.5 \text{ V},$                                  | $V_I = V_{CC}$ or GND            |          |                  | ±1       |        | ±1       |       | ±1   | μΑ   |  |
| lozh             |                | $V_{CC} = 5.5 \text{ V},$                                  | $V_0 = 2.7 \text{ V}$            |          |                  | 10       |        | 10       |       | 10   | μΑ   |  |
| lozL             |                | $V_{CC} = 5.5 \text{ V},$                                  | $V_0 = 0.5 V$                    |          |                  | -10      |        | -10      |       | -10  | μΑ   |  |
| I <sub>off</sub> |                | $V_{CC} = 0$ ,   | $V_I$ or $V_O \le 4.5 \text{ V}$ |          |                  | ±100     |        |          |       | ±100 | μΑ   |  |
| ICEX             |                | V <sub>C</sub> C = 5.5 V,<br>V <sub>O</sub> = 5.5 V        | Outputs high                     |          |                  | 50       |        | 50       |       | 50   | μΑ   |  |
| IO <sup>‡</sup>  |                | $V_{CC} = 5.5 \text{ V},$                                  | V <sub>O</sub> = 2.5 V           | -50      | -100             | -180     | -50    | -180     | -50   | -180 | mA   |  |
|                  |                | V <sub>CC</sub> = 5.5 V,                                   | Outputs high                     |          |                  | 3        |        | 3        |       | 3    |      |  |
| ICC              |                | $I_{O} = 0$ ,  | Outputs low                      |          |                  | 34       |        | 34       |       | 34   | mA   |  |
|                  |                | $V_I = V_{CC}$ or GND                                      | Outputs disabled                 |          |                  | 3        |        | 3        |       | 3    |      |  |
|                  | Data           | V <sub>CC</sub> = 5.5 V,<br>One input at 3.4 V,            | Outputs enabled                  |          |                  | 1        |        | 1.5      |       | 1    |      |  |
| ΔICC§            | inputs         | Other inputs at VCC or GND                                 |                                  |          | 0.05             |          | 1      |          | 0.05  | mA   |      |  |
|                  | Control inputs | $V_{CC} = 5.5 \text{ V}$ , One in Other inputs at $V_{CC}$ |                                  |          | 1.5              |          | 1.5    |          | 1.5   |      |      |  |
| Ci               |                | V <sub>I</sub> = 2.5 V or 0.5 V                            |                                  |          | 3.5              |          |        |          |       |      | pF   |  |
| Co               |                | V <sub>O</sub> = 2.5 V or 0.5 V                            |                                  |          | 7.5              |          |        |          |       |      | pF   |  |

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter does not apply.

<sup>§</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than VCC or GND.



<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ .

<sup>‡</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

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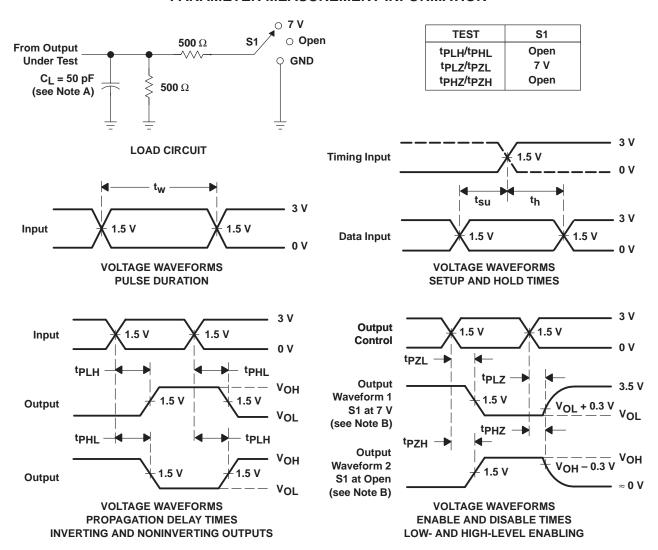
switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L$  = 50 pF (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>(</sub> | CC = 5 V<br>4 = 25°C | ',<br>; | MIN | MAX | UNIT |
|------------------|-----------------|----------------|----------------|----------------------|---------|-----|-----|------|
|                  |                 |                | MIN            | TYP                  | MAX     |     |     |      |
| t <sub>PLH</sub> | Δ               |                | 0.9            | 2.7                  | 3.4     | 0.9 | 3.8 | ns   |
| <sup>t</sup> PHL | A               | ı              | 0.9            | 2.7                  | 3.9     | 0.9 | 4.6 | 115  |
| <sup>t</sup> PZH | OE or OE        |                |                | 3.3                  | 4.2     | 1.2 | 5.1 | ns   |
| t <sub>PZL</sub> | OE or OE        | ı              | 1.3            | 3.4                  | 5.9     | 1.3 | 7   | 115  |
| <sup>t</sup> PHZ | OE or OE        | <b>\</b>       | 1.5            | 4.1                  | 5.5     | 1.5 | 7   | ns   |
| <sup>t</sup> PLZ | OE OF OE        | ī              | 1.7            | 3.6                  | 5.1     | 1.7 | 5.7 | 115  |

switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L$  = 50 pF (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT)     | TO<br>(OUTPUT) | V(  | CC = 5 V<br>4 = 25°C | /,<br>; | MIN | MAX | UNIT |
|------------------|---------------------|----------------|-----|----------------------|---------|-----|-----|------|
|                  |                     |                | MIN | TYP                  | MAX     |     |     |      |
| t <sub>PLH</sub> | Δ.                  | V              | 1   | 2.7                  | 3.4     | 1   | 3.7 | ns   |
| t <sub>PHL</sub> | A                   | ı              | 1   | 2.7                  | 3.9     | 1   | 4.5 | 115  |
| <sup>t</sup> PZH | OE or OE            | V              | 1.2 | 3.3                  | 4.2     | 1.2 | 5   | ns   |
| t <sub>PZL</sub> | OE OF OE            | ı              | 1.3 | 3.4                  | 5.9     | 1.3 | 6.9 | 115  |
| <sup>t</sup> PHZ | OE or <del>OE</del> |                | 1.5 | 4.1                  | 5.2     | 1.5 | 6.2 | ns   |
| t <sub>PLZ</sub> | OE OF OE            | <b>'</b>       | 1.7 | 3.6                  | 5.1     | 1.7 | 5.6 | 115  |

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_{Q}$  = 50  $\Omega$ ,  $t_{f} \leq$  2.5 ns,  $t_{f} \leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms







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#### **PACKAGING INFORMATION**

| Orderable Device   | Status  | Package Type | Package<br>Drawing |    | Package<br>Qty | Eco Plan                   | Lead/Ball Finish (6) | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5)                        | Samples |
|--------------------|---------|--------------|--------------------|----|----------------|----------------------------|----------------------|--------------------|--------------|---|---------|
| 5962-9450101QXA    | LIFEBUY | CFP          | WD                 | 48 | 1              | TBD                        | A42                  | N / A for Pkg Type | -55 to 125   | 5962-9450101QX<br>A<br>SNJ54ABT16241A<br>WD |         |
| SN74ABT16241ADGGR  | ACTIVE  | TSSOP        | DGG                | 48 | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -40 to 85    | ABT16241A                                   | Samples |
| SN74ABT16241ADGVR  | ACTIVE  | TVSOP        | DGV                | 48 | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -40 to 85    | AH241A                                      | Samples |
| SN74ABT16241ADL    | ACTIVE  | SSOP         | DL                 | 48 | 25             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -40 to 85    | ABT16241A                                   | Samples |
| SN74ABT16241ADLR   | ACTIVE  | SSOP         | DL                 | 48 | 1000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -40 to 85    | ABT16241A                                   | Samples |
| SN74ABT16241ADLRG4 | ACTIVE  | SSOP         | DL                 | 48 | 1000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM | -40 to 85    | ABT16241A                                   | Samples |
| SNJ54ABT16241AWD   | LIFEBUY | CFP          | WD                 | 48 | 1              | TBD                        | A42                  | N / A for Pkg Type | -55 to 125   | 5962-9450101QX<br>A<br>SNJ54ABT16241A<br>WD |         |

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



## PACKAGE OPTION ADDENDUM

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(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54ABT16241A, SN74ABT16241A:

Catalog: SN74ABT16241A

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Military: SN54ABT16241A

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

Military - QML certified for Military and Defense Applications

# PACKAGE MATERIALS INFORMATION

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# TAPE AND REEL INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device Device     | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74ABT16241ADGGR | TSSOP           | DGG                | 48 | 2000 | 330.0                    | 24.4                     | 8.6        | 13.0       | 1.8        | 12.0       | 24.0      | Q1               |
| SN74ABT16241ADGVR | TVSOP           | DGV                | 48 | 2000 | 330.0                    | 16.4                     | 7.1        | 10.2       | 1.6        | 12.0       | 16.0      | Q1               |
| SN74ABT16241ADLR  | SSOP            | DL                 | 48 | 1000 | 330.0                    | 32.4                     | 11.35      | 16.2       | 3.1        | 16.0       | 32.0      | Q1               |

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\*All dimensions are nominal

| 7 til dillionolollo alo nominal |                               |     |      |      |             |            |             |
|---------------------------------|-------------------------------|-----|------|------|-------------|------------|-------------|
| Device                          | Device Package Type Package D |     | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| SN74ABT16241ADGGR               | TSSOP                         | DGG | 48   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74ABT16241ADGVR               | TVSOP                         | DGV | 48   | 2000 | 367.0       | 367.0      | 38.0        |
| SN74ABT16241ADLR                | SSOP                          | DL  | 48   | 1000 | 367.0       | 367.0      | 55.0        |

## WD (R-GDFP-F\*\*)

#### **CERAMIC DUAL FLATPACK**

#### **48 LEADS SHOWN**



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only
- E. Falls within MIL STD 1835: GDFP1-F48 and JEDEC MO-146AA

GDFP1-F56 and JEDEC MO-146AB

# DL (R-PDSO-G48)

# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

PowerPAD is a trademark of Texas Instruments.



# DGV (R-PDSO-G\*\*)

#### **24 PINS SHOWN**

#### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

# DGG (R-PDSO-G\*\*)

# PLASTIC SMALL-OUTLINE PACKAGE

#### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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